

INTERNATIONAL STANDARD

NORME INTERNATIONALE

Electric components – Reliability – Reference conditions for failure rates and stress models for conversion

Composants électriques – Fiabilité – Conditions de référence pour les taux de défaillance et modèles de contraintes pour la conversion



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INTERNATIONAL ELECTROTECHNICAL COMMISSION

ELECTRIC COMPONENTS – RELIABILITY – REFERENCE CONDITIONS FOR FAILURE RATES AND STRESS MODELS FOR CONVERSION

FOREWORD

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International Standard IEC 61709 has been prepared by IEC technical committee 56: Dependability.

This second edition cancels and replaces the first edition, published in 1996 and constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- the addition of a number of component types and the updating of models for a large number of component types;
- the addition of annexes on reliability prediction, sources of failure rate data and component classification information.

The text of this standard is based on the following documents:

FDIS	Report on voting
56/1422/FDIS	56/1431/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

INTRODUCTION

This International Standard is intended for the reliability prediction of components as used in equipment and is aimed at organizations that have their own data and describes how to state and use that data in order to perform reliability predictions.

It can also be used to allow an organization to set up a failure rate database and describes the reference conditions for which field failure rates should be stated. The reference conditions adopted in this standard are typical of the majority of applications of components in equipment however when components operate under other conditions the users may consider stating these conditions as their reference conditions.

Using the presented stress models allows extrapolation of failure rates to other operating conditions which in turn permits the prediction of failure rates at assembly level. This allows estimation of the effect of design changes or changes in the environmental conditions on component reliability. Reliability prediction is most useful in the early design phase of electrical equipment. It can be used, for example, to identify potential reliability problems, the planning of logistic support strategies and the evaluation of designs.

The stress models contained herein are generic and are as simple as possible while still being comparable with more complex equations contained in other models.

This standard does not contain failure rates, but it describes how they can be stated and used. This approach allows a user to select the most relevant and up to date failure rates for the prediction from a source that they select. This standard also contains information on how to select the data that can be used in the presented models.

ELECTRIC COMPONENTS – RELIABILITY – REFERENCE CONDITIONS FOR FAILURE RATES AND STRESS MODELS FOR CONVERSION

1 Scope

This International Standard gives guidance on how failure rate data can be employed for reliability prediction of electric components in equipment.

Reference conditions are numerical values of stresses that are typically observed by components in the majority of applications. Reference conditions are useful since they are the basis of the calculation of failure rate under any conditions by the application of stress models that take into account the actual operating conditions. Failure rates stated at reference conditions allow realistic reliability predictions to be made in the early design phase.

The stress models described herein are generic and can be used as a basis for conversion of the failure rate data at these reference conditions to actual operating conditions when needed and this simplifies the prediction approach. Conversion of failure rate data is only permissible within the specified functional limits of the components.

This standard also gives guidance on how a database of component failure data can be constructed to provide failure rates that can be used with the included stress models. Reference conditions for failure rate data are specified, so that data from different sources can be compared on a uniform basis. If failure rate data are given in accordance with this International Standard then no additional information on the specified conditions is required.

This standard does not provide base failure rates for components – rather it provides models that allow failure rates obtained by other means to be converted from one operating condition to another operating condition.

The prediction methodology described in this standard assumes that the parts are being used within its useful life. The methods in this standard have a general application but are specifically applied to a selection of component types as defined in Clause 6 and Clause E.2.

2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60050-191, *International Electrotechnical Vocabulary – Part 191: Dependability and quality of service*

IEC 60605-6, *Equipment reliability testing – Part 6: Tests for the validity and estimation of the constant failure rate and constant failure intensity*

IEC 60721-3-3, *Classification of environmental conditions – Part 3: Classification of groups of environmental parameters and their severities – Section 3: Stationary use at weather protected locations*

IEC 60721-3-4, *Classification of environmental conditions – Part 3: Classification of groups of environmental parameters and their severities – Section 4: Stationary use at non-weatherprotected locations*

IEC 60721-3-5, *Classification of environmental conditions – Part 3: Classification of groups of environmental parameters and their severities – Section 4: Ground vehicle installations*

IEC 60721-3-7, *Classification of environmental conditions – Part 3: Classification of groups of environmental parameters and their severities – Section 7: Portable and non-stationary use*

3 Terms, definitions and symbols

3.1 Terms and definitions

For the purpose of this document, the terms and definitions of IEC 60050-191, as well as the following terms and definitions apply.

3.1.1

electric component

component with conductive terminals through which voltages or currents may be applied or delivered

[IEC 61360-1:2009, 2.18]

NOTE The term electric component includes the commonly used terms “electronic component”, “electrical component” and “electro-mechanical component”.

3.1.2

failure (of an item)

loss of ability to perform as required

NOTE 1 When the loss of ability is caused by a pre-existing latent fault, the failure occurs when a particular set of circumstances is encountered.

NOTE 2 A failure of an item is an event that results in a fault in that item, which is a state.

3.1.3

failure mode

manner in which failure occurs

NOTE A failure mode may be defined by the function lost or the state transition that occurred.

3.1.4

instantaneous failure rate

failure rate

limit, if it exists, of the ratio of the conditional probability that the instant of a failure of a non-repairable item occurs within time interval $(t, t + \Delta t)$ to Δt when Δt tends to zero, given that it has not failed within time interval $(0, t)$

NOTE 1 The instantaneous failure rate, $\lambda(t)$, is expressed by the formula:

$$\lambda(t) = \lim_{\Delta t \rightarrow 0} \frac{1}{\Delta t} \frac{F(t + \Delta t) - F(t)}{R(t)} = \frac{f(t)}{R(t)}$$

where $F(t)$ and $f(t)$ are respectively the distribution function and the probability density of the failure instant, and where $R(t)$ is the reliability function, related to the reliability $R(t_1, t_2)$ by $R(t) = R(0, t)$.

NOTE 2 See IEC 61703.